Power MOSFET 60 V, 0.81 mΩ, 398.2 A, Single N–Channel

Features

- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Power 88 Package, Industry Standard
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

	(.) =0			-	
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	Ι _D	398.2	А
Current R _{θJC} (Notes 1, 3)	Steady State	T _C = 100°C		281.6	
Power Dissipation		$T_{C} = 25^{\circ}C$	PD	244	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		122	
Continuous Drain	Steady State	T _A = 25°C	۱ _D	56.9	А
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		40.2	
Power Dissipation		T _A = 25°C	PD	5.0	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		2.5	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	203.4	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 30 \text{ A}$)			E _{AS}	887	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.614	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	30.1	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

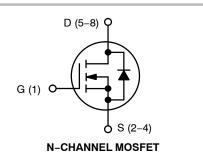
 Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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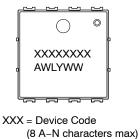
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	0.81 mΩ @ 10 V	000.0.4	
	1.05 mΩ @ 4.5 V	398.2 A	





MARKING DIAGRAM



- A = Assembly Location
- WL = 2-digit Wafer Lot Code
- Y = Year Code
- WW = Work Week Code

ORDERING INFORMATION

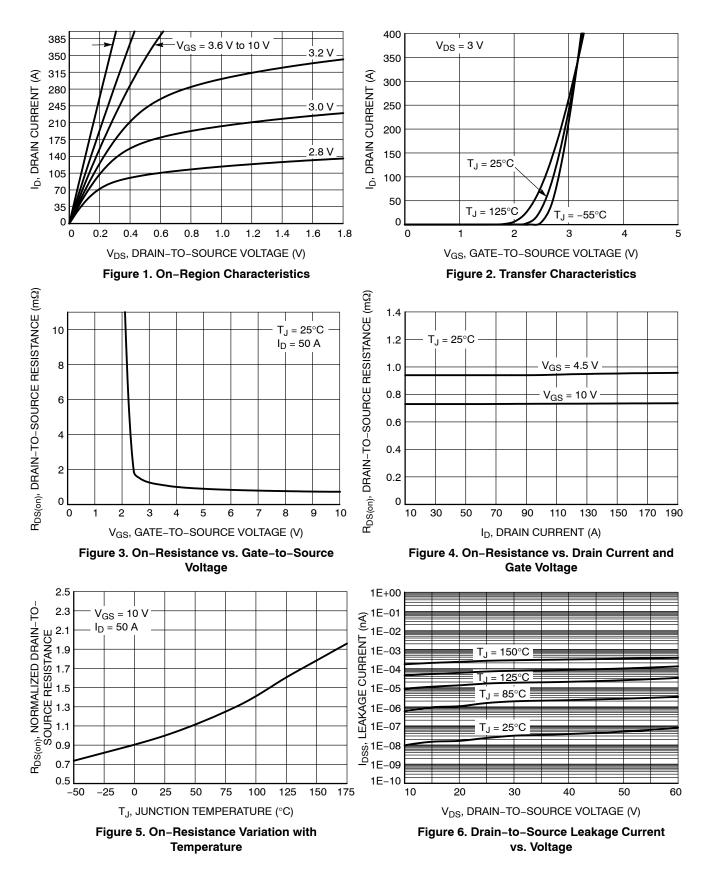
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

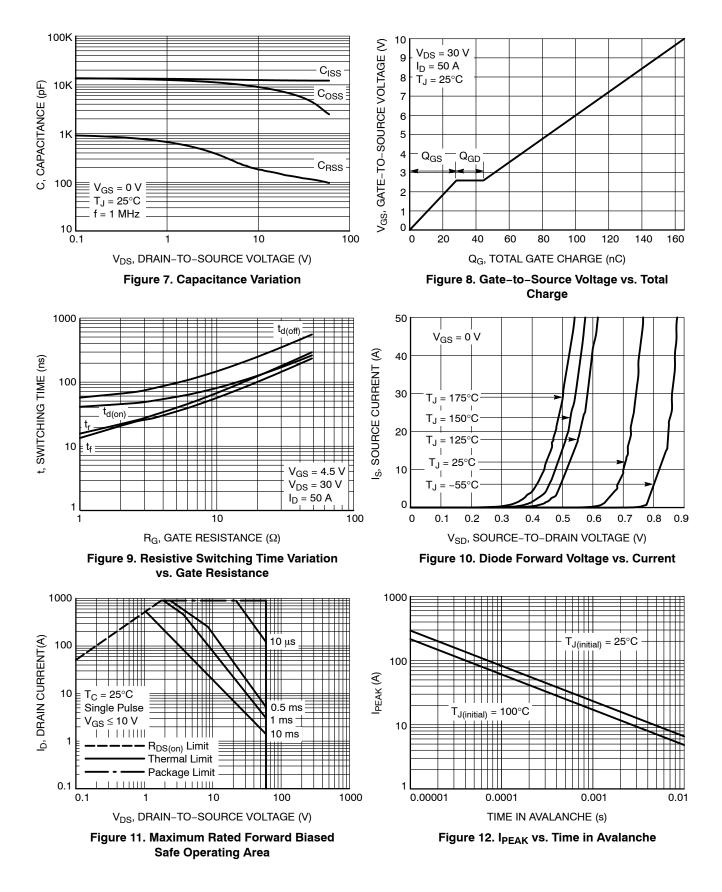
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u> </u>						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$			25		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25 °C T _J = 125°C			10 250	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	Ŭ			100	nA
ON CHARACTERISTICS (Note 4)		20 . 4	•				
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D	= 250 μA	1.2		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 250 μA, re	ef to 25°C		-5.53		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.73	0.81	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		0.94	1.05	mΩ
Forward Transconductance	9FS	V _{DS} =15 V, I _E	₀ = 50 A		275		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}				12300		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 M⊢	lz, V _{DS} = 25 V		6225		pF
Reverse Transfer Capacitance	C _{RSS}				130		1
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 50 A			165		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			74.3		nC
Threshold Gate Charge	Q _{G(TH)}				15.6		
Gate-to-Source Charge	Q _{GS}				28.7		nC
Gate-to-Drain Charge	Q _{GD}				14.7		
Plateau Voltage	V _{GP}				2.59		V
SWITCHING CHARACTERISTICS (Note !	5)						
Turn-On Delay Time	t _{d(ON)}				47.2		
Rise Time	t _r	V _{GS} = 4.5 V, V _F	_{ns} = 30 V,		25.2		ns
Turn-Off Delay Time	t _{d(OFF)}	V _{GS} = 4.5 V, V _E I _D = 50 A, R _G	= 2.5 Ω		70.7		
Fall Time	t _f				23.3		1
DRAIN-SOURCE DIODE CHARACTERIS	STICS			-		-	
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.77	1.2	
			T _J = 125°C		0.63		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			98.9		
Charge Time	t _a				66.8		ns
Discharge Time	t _b				32.1		
Reverse Recovery Charge	Q _{RR}				229		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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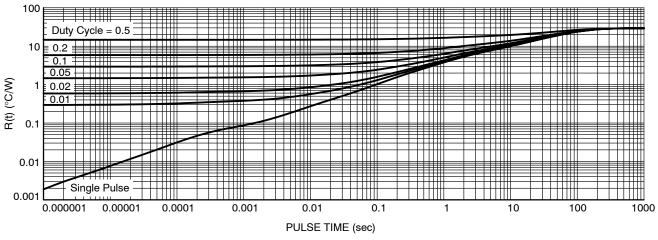


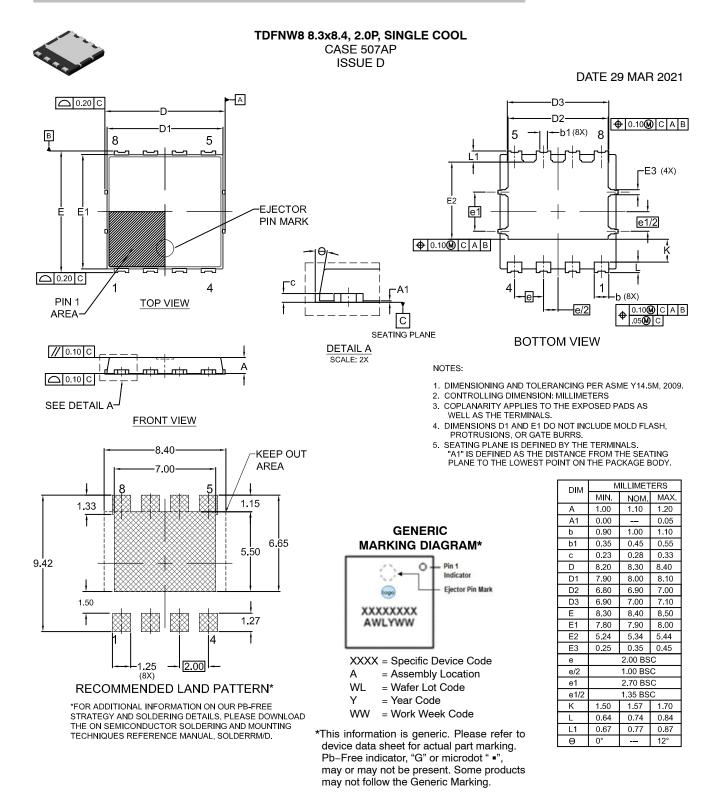
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMTS001N06CLTXG	001N06CL	POWER 88 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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